ASSOCIATION CONNECT	© Copyright 2005, IPC.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						Mfg Ir	formatio	n		
Supplier Infor	mation															
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*				
nsemi													2023-06-08			
Contact Name		Title - Contact			I	Phone - Contact*				Emai	Email - Contact*					
Product-Env-Stev	wards	Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com					
Authorized Representative* Title				Title - Representative			Phone - Representative*				Emai	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com				
Reques	ster Item Number Mfr Iter		Item Number Mfr Item Name				Effective Dat	e Version	n N	Manufacturing Site		Weight*		UOM	Unit Type	
		MC14052BDTR2G LOG CM		LOG CMOS ML	OG CMOS MLTIPLXR DUAL		2023-06-08 PH1			45.4		mg	Each			
Ianufacturing	g Proccess Information	n														
Termina	l Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MS	020 MSL Rating		Peak Process Body Temperature		Max Time a	ne at Peak Tempera		Number	of Reflow Cyc	les	
Preciou Sn)	Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		C 30		sec	onds	3			
Comments																
vel 1 - maximum	n time at peak temperature (during sol	ldering is 10-3	0 seconds						·						
or more informa	ation regarding material con	nposition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.0	mg	Supplier	Silicon (Si)	7440-21-3		2	mg
Die Attach	1.32	mg		Epoxy resin	proprietary data		0.3036	mg
			Supplier	Silver (Ag)	7440-22-4		1.0164	mg
Lead Frame	20.76	mg	Supplier	Silver (Ag)	7440-22-4		0.0623	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0394	mg
			Supplier	Iron (Fe)	7439-89-6		0.5377	mg
			Supplier	Copper (Cu)	7440-50-8		20.0915	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0291	mg
Mold Compound-Black	19.0	mg		Epoxy resin	proprietary data		0.95	mg
			Supplier	Phenol Resin	Proprietary Data		0.76	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.9	mg
			Supplier	Carbon Black (C)	1333-86-4		0.19	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		15.2	mg
Plating	2.12	mg	Supplier	Palladium (Pd)	7440-05-3		0.1611	mg
			В	Nickel (Ni)	7440-02-0		1.9292	mg
			Supplier	Gold (Au)	7440-57-5		0.0297	mg
Wire Bond	0.2	mg	Supplier	Palladium (Pd)	7440-05-3		0.002	mg
			Supplier	Copper (Cu)	7440-50-8		0.198	mg